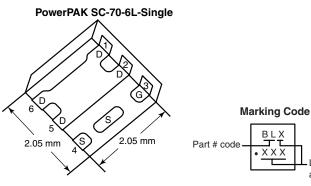
New Product



SiA433EDJ **Vishay Siliconix**

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
	0.018 at V _{GS} = - 4.5 V	- 12 ^a		
- 20	0.026 at V _{GS} = - 2.5 V	- 12 ^a	20 nC	
	0.065 at V _{GS} = - 1.8 V	- 4		



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
- Small Footprint Area
- Low On-Resistance
- 100 % R_g Tested Built in ESD Protection with Zener Diode
- Typical ESD Performance: 1800 V
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Portable Devices
- Load Switch
- Battery Switch - Charger Switch
- G C

Ordering Information: SiA433EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Lot Traceability and Date code

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unles Parameter		Symbol Limit		Unit	
Drain-Source Voltage		V _{DS}	- 20	V	
Gate-Source Voltage		V _{GS}	± 12		
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C T _C = 70 °C		- 12 ^a - 12 ^a	_	
	T _A = 25 °C T _A = 70 °C		- 11.3 ^{b, c} - 9.1 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	- 50		
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	I _S	- 12 ^a - 2.9 ^{b, c}	_	
Maximum Power Dissipation	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{C} = 25 °C$	P _D	19 12	w	
Operating Junction and Storage Temperature	$T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$		3.5 ^{b, c} 2.2 ^{b, c} - 55 to 150	_	
Operating Junction and Storage Temperature Range Soldering Recommendations (Peak Temperature) ^{d, e}		T _J , T _{stg}	260	°C	

THERMAL RESISTANCE BATINGS

Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5		

Notes:

a. Package limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 80 °C/W.



S

P-Channel MOSFET

d. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

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SPECIFICATIONS $T_J = 25 \degree C$, unless oth						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1			1	1	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 12		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.5		- 1.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 20		
		$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 0.5		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	- μA -	
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}$ - 5 V, V_{GS} = - 4.5 V	- 20			Α	
		V _{GS} = - 4.5 V, I _D = - 7.6 A		0.015	0.018		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 6.3 A		0.021	0.026	Ω	
		V _{GS} = - 1.8 V, I _D = - 2.5 A		0.040	0.065		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 7.6 A		35		S	
Dynamic ^b				•			
Total Gate Charge	0	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -11 \text{ A}$		50	75	-	
-	Qg			20	30		
Gate-Source Charge	Q _{gs}	Q_{gs} V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 11 A		3.3		nC	
Gate-Drain Charge	Q _{gd}			8.4		1	
Gate Resistance	Rg	f = 1 MHz	0.2	1	2	kΩ	
Turn-On Delay Time	t _{d(on)}			0.71	1.1		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1 Ω		1.7	2.6		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 9 A, V_GEN = - 4.5 V, R_g = 1 Ω		6	9		
Fall Time	t _f			3.2	5		
Turn-On Delay Time	t _{d(on)}			0.3	0.45	us	
Rise Time	t _r t _{d(off)} I _D	V_{DD} = - 10 V, R_L = 1 Ω		0.6	0.9	-	
Turn-Off Delay Time		$I_D \cong$ - 9 A, V_{GEN} = - 10 V, R_g = 1 Ω		10	15		
Fall Time	t _f			3.5	5.5		
Drain-Source Body Diode Characterist	ics			1	1	1	
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			- 12	٨	
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V _{SD}	$I_{\rm S} = -9$ A, $V_{\rm GS} = 0$ V		- 0.85	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	t _{rr}		30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			20	40	nC	
Reverse Recovery Fall Time	ta	$I_F = 9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 \text{ °C}$		13			
Reverse Recovery Rise Time	t _b			17		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

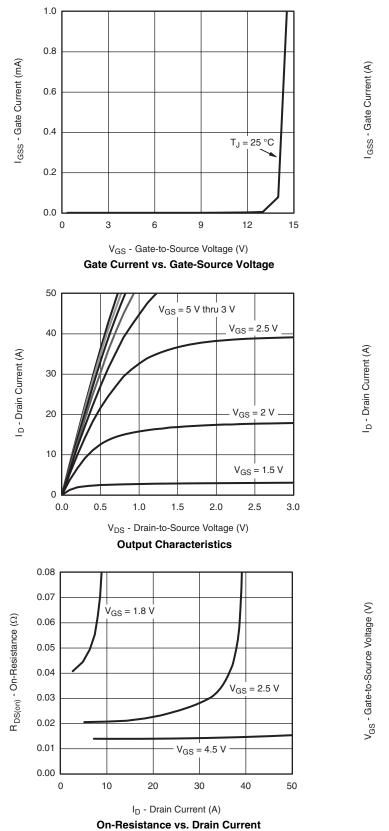
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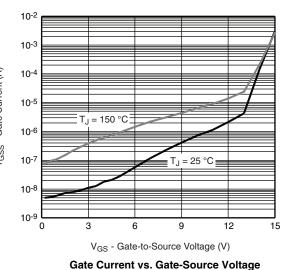


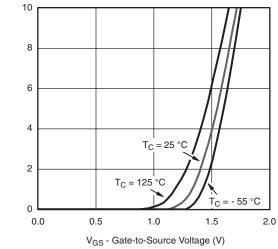
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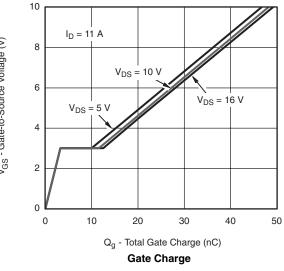
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted











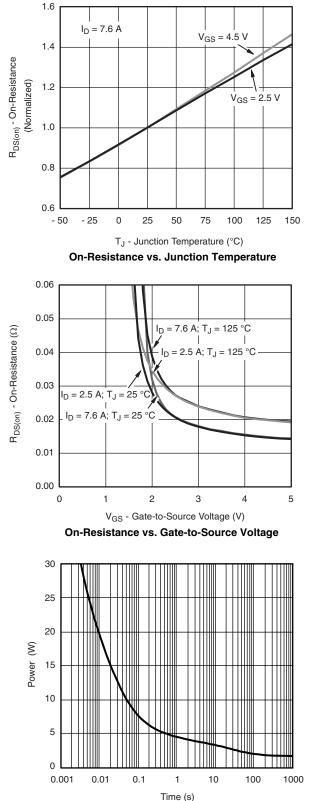
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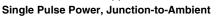
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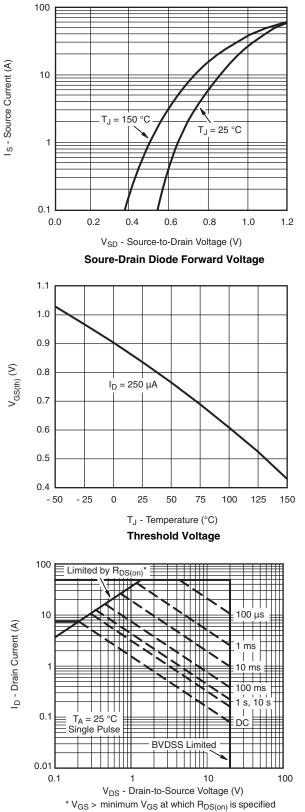
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Safe Operating Area, Junction-to-Ambient

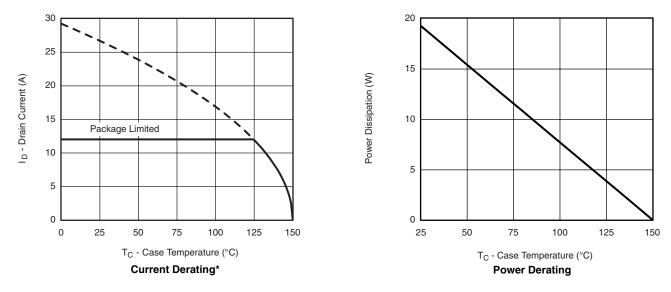
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



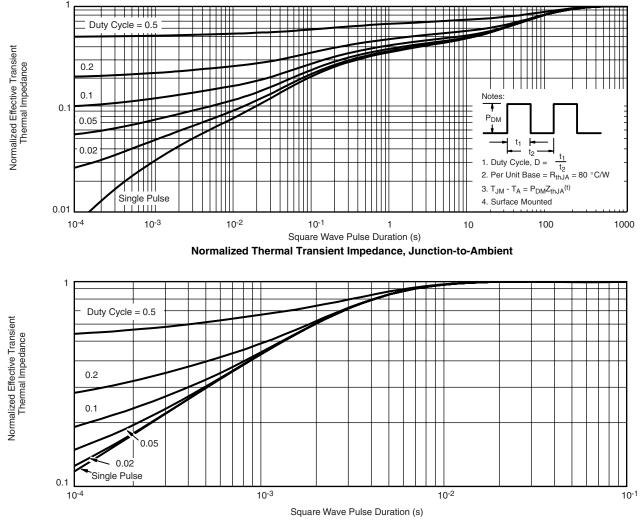
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?65472</u>.



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

Vishay Siliconix

¹



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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Vishay

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